



15A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features and Benefits

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 150A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish, RoHS Compliant (Note 1)

Mechanical Data

Case: D²PAK

 Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020

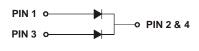
Terminals: Finish — Tin. Solderable per MIL-STD-202, Method

Polarity: See Diagram

Weight: 1.7 grams (approximate)







Polarity

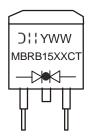
Ordering Information (Note 2)

| Device | Packaging | Shipping |
|--------------|--------------------|--------------------------|
| MBRB1530CT-T | D ² PAK | 800/Tape & Reel, 13-inch |
| MBRB1535CT-T | D ² PAK | 800/Tape & Reel, 13-inch |
| MBRB1540CT-T | D ² PAK | 800/Tape & Reel, 13-inch |
| MBRB1545CT-T | D ² PAK | 800/Tape & Reel, 13-inch |

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes
- 2. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



MBRB15XXCT = Product Type Marking Code Where xx = 30, 35, 40 or 45, Depending on Device Type J!! = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 2 for 2002) WW = Week Code (01 to 53)



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | MBRB 1530CT | MBRB 1535CT | MBRB 1540CT | MBRB 1545CT | Unit |
|---|--|----------------|----------------|----------------|----------------|-------------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 30 | 35 | 40 | 45 | > |
| RMS Reverse Voltage | V _{R(RMS)} | 21 | 24.5 | 28 | 31.5 | V |
| Average Rectified Output Current @ T _C = 105°C | lo | | 1 | 5 | | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | | 1: | 50 | | Α |

Thermal Characteristics

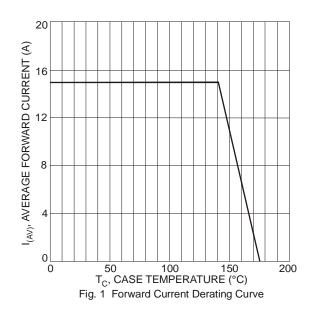
| Characteristic | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Typical Thermal Resistance Junction to Terminal | $R_{	hetaJT}$ | 3.0 | °C/W |
| Operating and Storage Temperature Range (Note 3) | $T_{J_i}T_{STG}$ | -65 to +175 | °C |

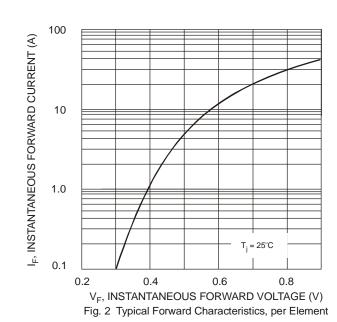
Electrical Characteristics @TA = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit | |
|---|--------------------|-----------|------|--|
| Forward Voltage, per Element @ I _F = 7. | 5A V _{FM} | 0.7 | V | |
| Voltage Rate of Change | dv/dt | 10,000 | V/µs | |
| Peak Reverse Current $@T_A = 25$ at Rated DC Blocking Voltage (Note 4) $@T_A = 100$ | IDM | 0.1 15 | mA | |
| Maximum Reverse Recovery Time (Note 5) | t _{rr} | 30 | ns | |
| Typical Total Capacitance (Note 6) | Ст | 250 | pF | |

Notes:

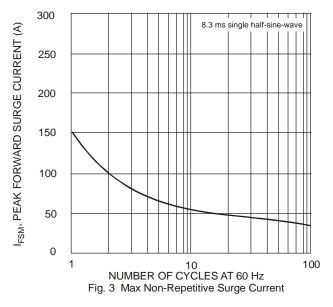
- 3. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- 4. 300µs pulse width, 2% duty cycle.
- 5. Reverse recovery test conditions: IF = 0.5A, IR = 1.0A, Irr = 0.25A (see figure 1).
- 6. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

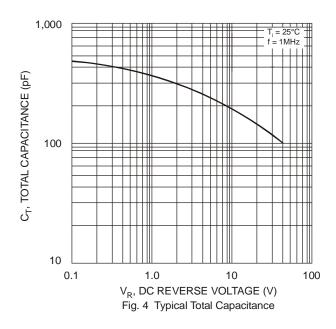


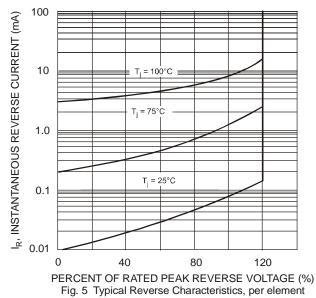




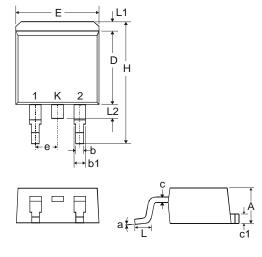








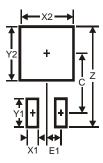
Package Outline Dimensions



| D ² PAK | | | |
|----------------------|----------|-------|--|
| Dim | Min | Max | |
| Α | 4.07 | 4.82 | |
| b | 0.51 | 0.99 | |
| b1 | 1.15 | 1.77 | |
| С | 0.356 | 0.58 | |
| c1 | 1.143 | 1.65 | |
| D | 8.39 | 9.65 | |
| Е | 9.66 | 10.66 | |
| е | 2.54 Typ | | |
| Η | 14.61 | 15.87 | |
| L | 1.78 | 2.79 | |
| L1 | _ | 1.67 | |
| L2 | _ | 1.77 | |
| а | 0° | 8° | |
| All Dimensions in mm | | | |



Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 16.9 |
| X1 | 1.1 |
| X2 | 10.8 |
| Y1 | 3.5 |
| Y2 | 11.4 |
| С | 9.5 |
| E1 | 2.5 |

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